






# THE DATASHEET OF GBLC03C



**SPECIFICATION SHEET**

<b>SPECIFICATION SHEET NO.</b>	N1004- SOD323LC03CSCC
<b>DATE</b>	Oct. 04, 2021
<b>REVISION</b>	A0
<b>DESCRIPTION</b>	<p>SMD Plastic-Encapsulate ESD Protection Diodes, SOD-323 series, 2 pads            GBLC03C Type, Ultra Low Capacitance TVS Array <b>Bi-directional Channels</b>  <b>Reverse Working Voltage : 3.0V, Clamping Voltage 7VC Max.@1.0A</b></p> <p>Operating Temp. Range -55°C ~+150°C,            Package in Tape/Reel, 3000pcs/Reel            RoHS/RoHS III compliant</p>
<b>CUSTOMER</b>	
<b>CUSTOMER PART NUMBER</b>	
<b>CROSS REF. PART NUMBER</b>	
<b>ORIGINAL PART NUMBER</b>	MDD GBLC03C
<b>PART CODE</b>	SOD323LC03CSCC

<b>VENDOR APPROVE</b>			
Issued/Checked/Approved			
DATE: Oct. 04, 2021			

<b>CUSTOMER APPROVE</b>	
DATE:	

**SMD ESD PROTECTION DIODES SOD-323 SERIES**

**MAIN FEATURE**

- Peak power dissipation 300W (8/20µs)
- IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5 (Lightning) 12A (8/20µs)
- Protects one data I/O line (Bi-directional)
- Low clamping voltage
- Low leakage current
- Working Voltage 3V/5V/8V/12V/15V/24V
- Response Time is less than 1 ns
- Meet MSL 1 requirement



**APPLICATION**

- Cell phone handsets and accessories
- Notebooks, Desktops, and Servers Cellular
- Microprocessor based equipment
- USB Interface
- Portable Instrumentation
- Personal Digital Assistants (PDA's)
- Peripherals

**RFQ**

[Request For Quotation](#)

**PART CODE GUIDE**

SOD323	LC03C	S	CC
1	2	3	4

1) **SOD323**: SMD Plastic-Encapsulate ESD Protection Diodes, SOD-323 series, 2 pads

2) **LC03C**: Type code for original part number GBLC03C

3) **S**: Package code, Package in Tape/Reel, 3000pcs/Reel

4) **CC**: Marking code for "CC" on the case surface, Different Marking for different specification.

**SMD ESD PROTECTION DIODES SOD-323 SERIES**

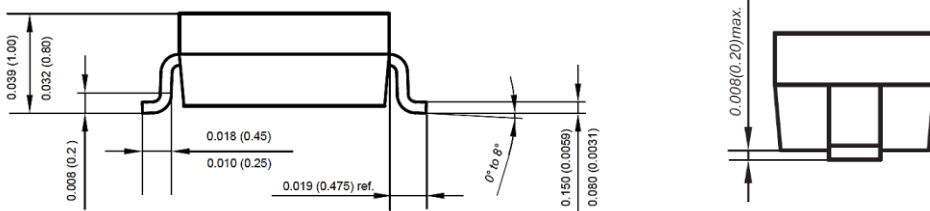
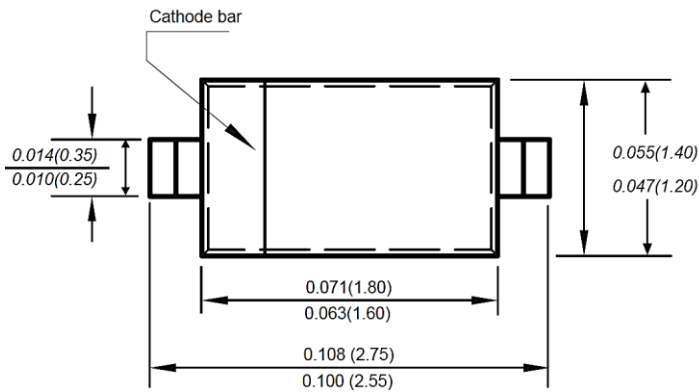
**DIMENSION (Unit: Inch/mm)**

Image for reference

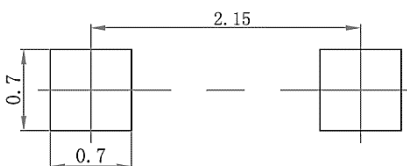


Marking: CC

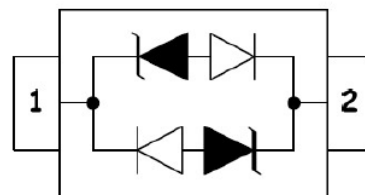
SOD-323



**Recommend Pad Layout**



**Circuit Diagram**



**SMD ESD PROTECTION DIODES SOD-323 SERIES**

**MECHANICAL DATA**

Case	Flammability Rating	Terminals	Mounting Position	Weight per piece
JEDEC SOT-323 molded plastic body	UL 94V-0	Matte tin plated	-	-

**ABSOLUTE MAX. RATINGS AT Ta=25 °C (unless otherwise specified)**

Parameter	SYMBOLS	VALUE	UNITS
		LIMIT	
ESD per IEC 61000-4-2 (Air)	V ESD	+/-15	KV
ESD per IEC 61000-4-2 (Contact)	V ESD	+/-8	KV
Peak Pulse Power @8/20µs	P PP	300	W
Operating Temperature Range	T J	-55 ~+ 150	°C
Storage Temperature Range	T STG	-55 ~ +150	°C
Lead Solder Temperature- Max. (10 sec. Duration)	T L	260 /10s	°C

**SMD ESD PROTECTION DIODES SOD-323 SERIES**

**ELECTRICAL CHARACTERISTICS ( Ta=25 °C unless otherwise specified)**

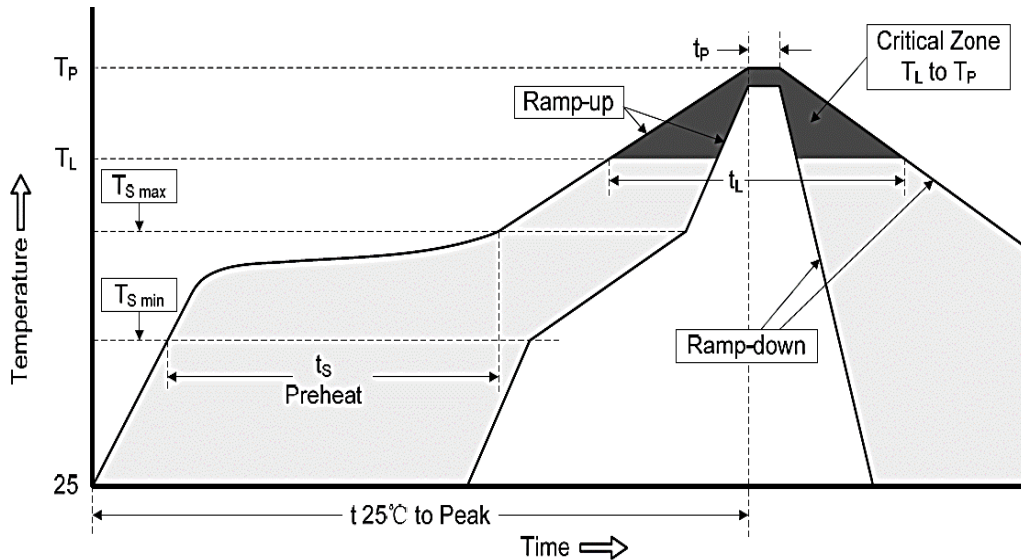
Parameter	SYMBOLS	VALUE			UNITS
		Min.	Typical	Max.	
<b>Reverse Working Voltage</b>	V <sub>RWM</sub>			3.0	V
<b>Reverse Breakdown Voltage @ I<sub>T</sub> = 1.0mA</b>	V <sub>BR</sub>	4.0			V
<b>Reverse Leakage Current @V<sub>RWM</sub> = 3V</b>	I <sub>R</sub>			2.0	μA
<b>Clamping Voltage @ I<sub>PP</sub> = 1.0A, t<sub>p</sub> = 8/20μs</b>	V <sub>C</sub>			7.0	V
<b>Clamping Voltage @ I<sub>PP</sub> = 8.0A, t<sub>p</sub> = 8/20μs</b>	V <sub>C</sub>			13.9	V
<b>Junction Capacitance @ V<sub>R</sub> = 0V, f = 1MHz</b>	C <sub>T</sub>		0.8		pF

**SMD ESD PROTECTION DIODES SOD-323 SERIES**
**RELIABILITY**

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

**SMD ESD PROTECTION DIODES SOD-323 SERIES**

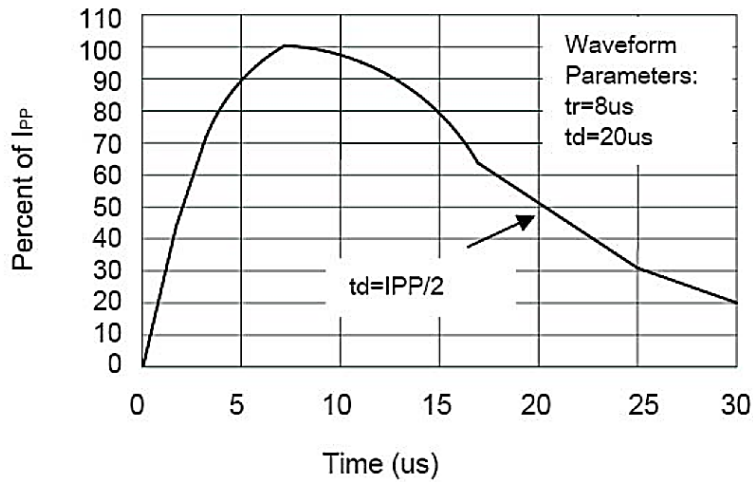
**SUGGESTED REFLOW PROFILE (For Reference Only)**



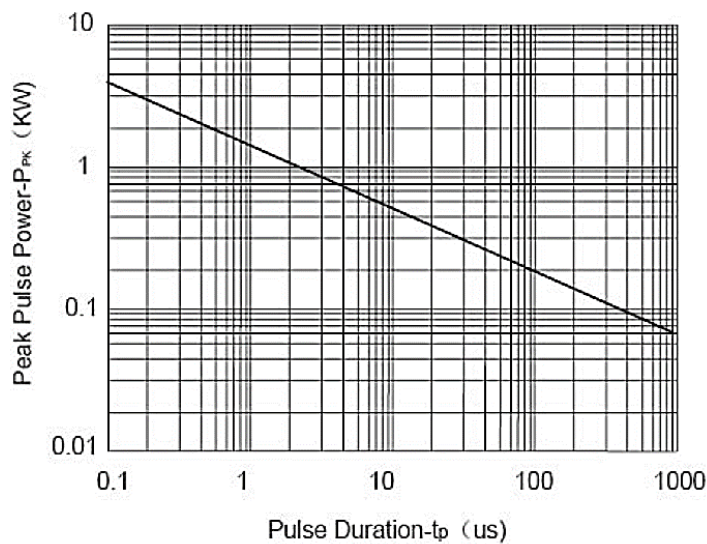
<b>Profile Feature</b>		Pb-Free Assembly
<b>Average Ramp-up Rate (Ts Max to Tp)</b>		3°C/second Max
<b>Preheat</b>	<b>Temperature Min (Ts Min.)</b>	150°C
	<b>Temperature Max (Ts Max.)</b>	200°C
	<b>Time (ts Min. to ts Max.)</b>	60 ~ 180 seconds
<b>Time maintained above</b>	<b>Temperature (Tl)</b>	217°C
	<b>Time (ti)</b>	60 ~ 150 seconds
<b>Peak/Classification Temperature (Tp)</b>		260 °C
<b>Time within 5°C of actual Peak Temperature (tp)</b>		20 ~ 40 seconds
<b>Ramp-down rate</b>		6 °C /Second Max.
<b>Time 25 °C to Peak Temperature</b>		8 minutes Max.
<b>Suggest reflow times</b>		3 Times Max.

**SMD ESD PROTECTION DIODES SOD-323 SERIES**

**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**



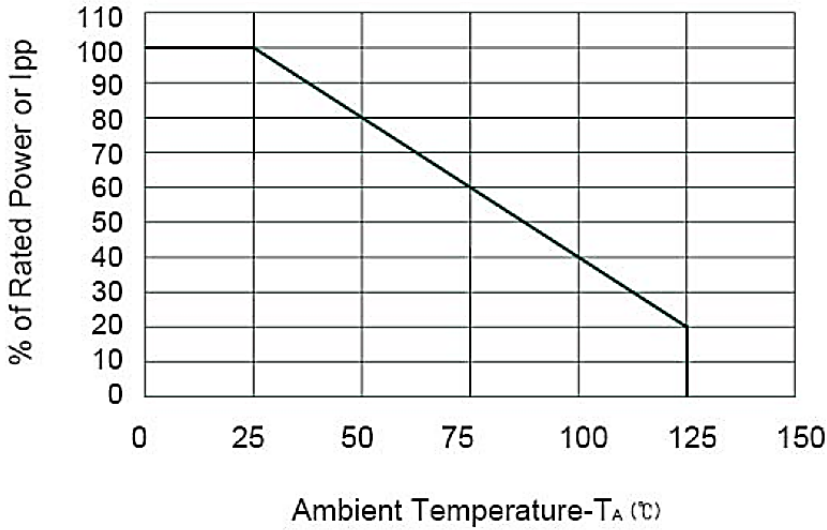
**Pulse Waveform**



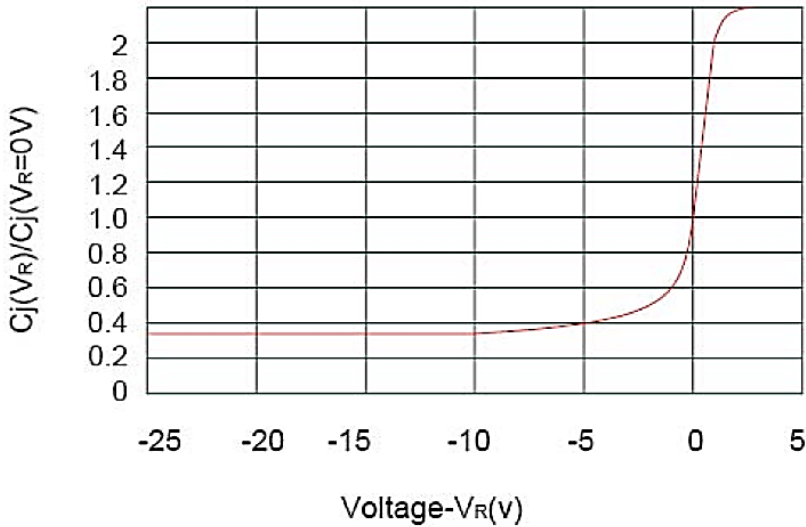
**Non-Repetitive Peak Pulse Power vs. Pulse Time**

**SMD ESD PROTECTION DIODES SOD-323 SERIES**

**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**



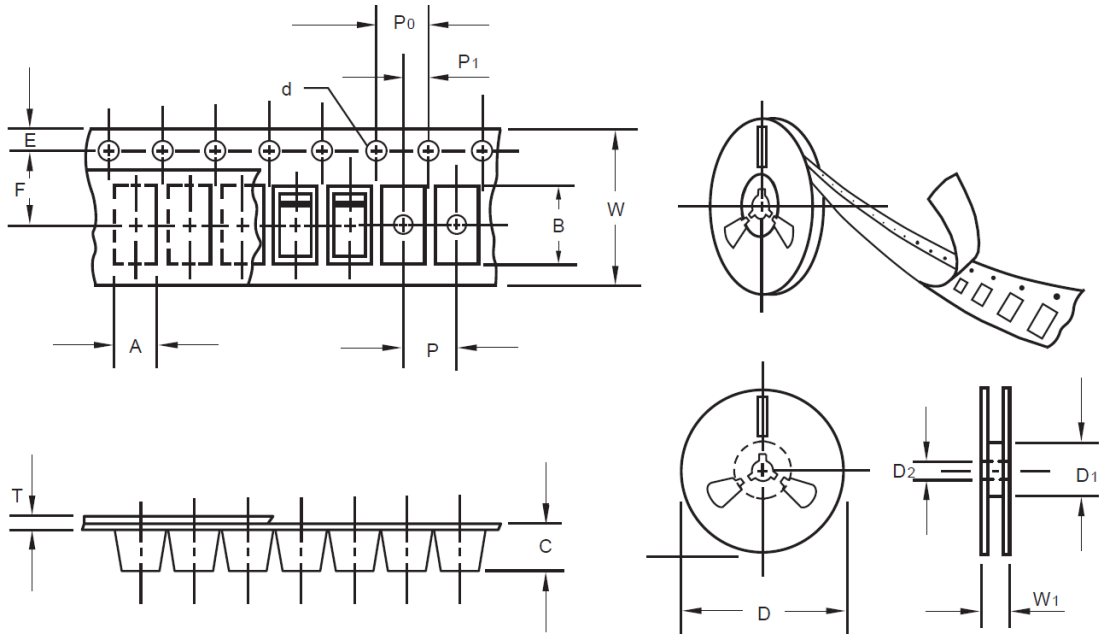
**Power Derating Curve**



**SMD ESD PROTECTION DIODES SOD-323 SERIES**

**TAPE/REEL (Unit: mm)**

All Devices are packed in accordance with EIA standard RS-481-A and specifications.



Item	Symbol	Tolerance	SO-323
Carrier width	A	0.1	1.46
Carrier Length	B	0.1	2.90
Carrier Depth	C	0.1	1.25
Sprocket hole	d	0.05	1.55
7"Reel outside diameter	D	2.0	178.00
7"Reel inner diameter	D1	Min.	50.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.06
Tape width	W	0.3	8.00
Reel width	W1	1.0	12.30

**SMD ESD PROTECTION DIODES SOD-323 SERIES**

**SPQ PACKAGE for Reference**

Item	Unit	Value
Case Code		SOD-323
Reel Size	Inch	7
Reel Size	mm	178
Tape Space	mm	/
SPQ /Reel	pcs	3000
Weigh /SPQ	LBS	-
Weigh /SPQ	KGs	-
Qty. Per Box	pcs	6,000
Inner Box	Inch	L8.0*W8.0*H1.5

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